# APPROVAL SHEET

To:

Customer P/N:

UDE P/N: RB1-125B8G1A

Description: RJ45 1X1 Tab Down

Through Hole

10/100/1000 Base-T

Contact Area: Gold Flash

LED:L-Green; R-Yellow



Spec No. Update Date Revision RB115260-00 2015/11/4 A

Approved	Checked	Prepared

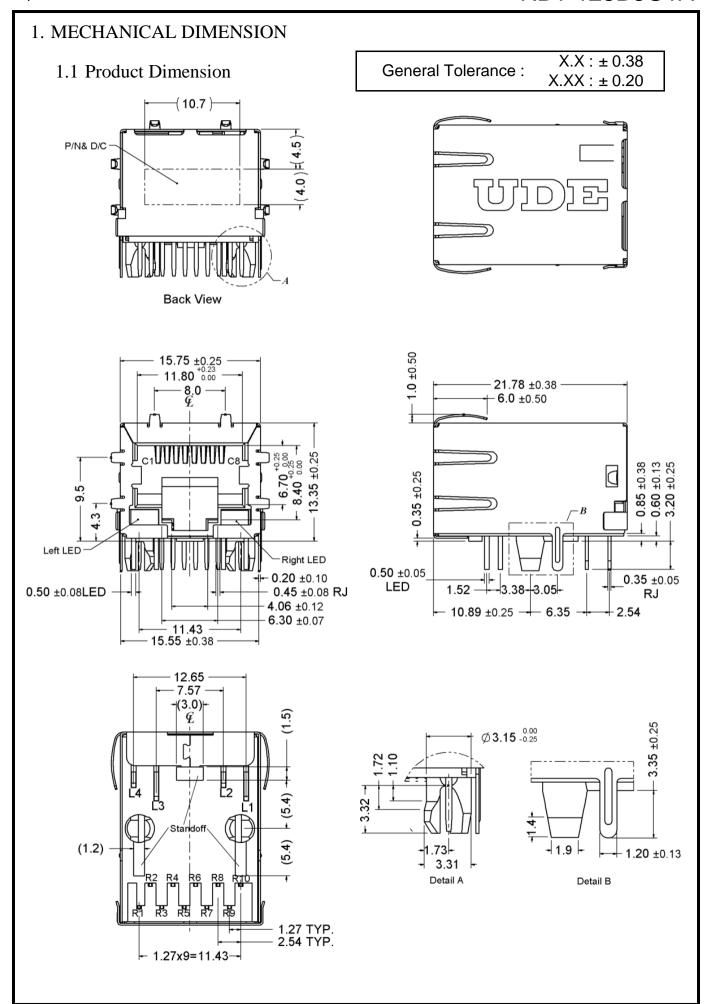


# 湧德電子 股份有限公司

8F-1, No.58, Tongde 11th St., Taoyuan City, Taoyuan County (330), Taiwan 桃園縣桃園市(330)同德十一街58號 8F之1

TEL:+886-3-3568600 FAX:+886-3-3560611

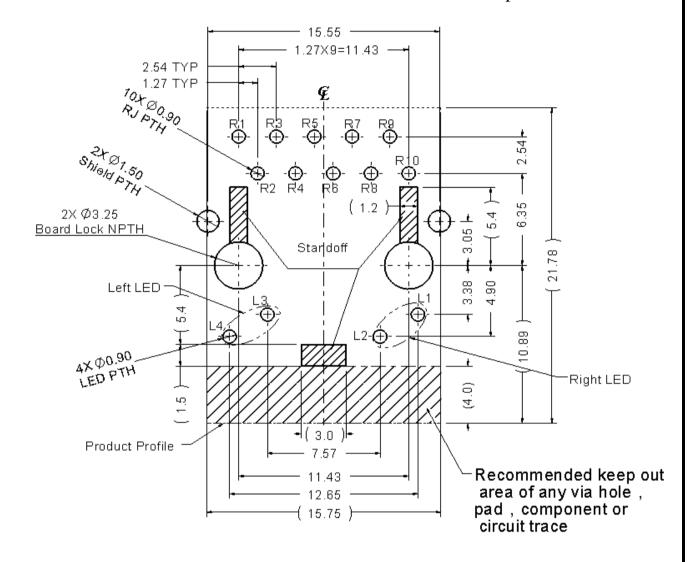
http://www.ude-corp.com/



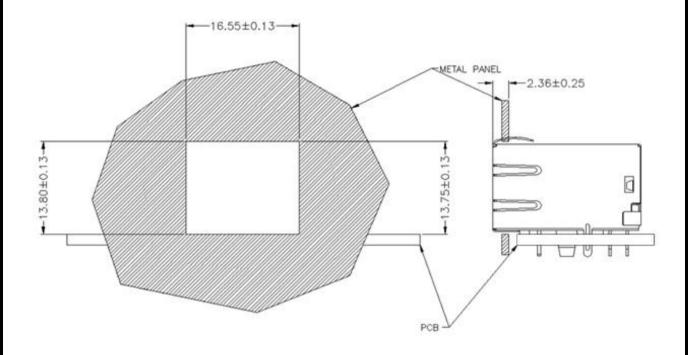
#### 1.2 Recommended PCB Layout

#### Component Side of Board

All dimension tolerances are  $\pm 0.05$ mm unless otherwise specified



# 1.3 Recommended Panel cutout

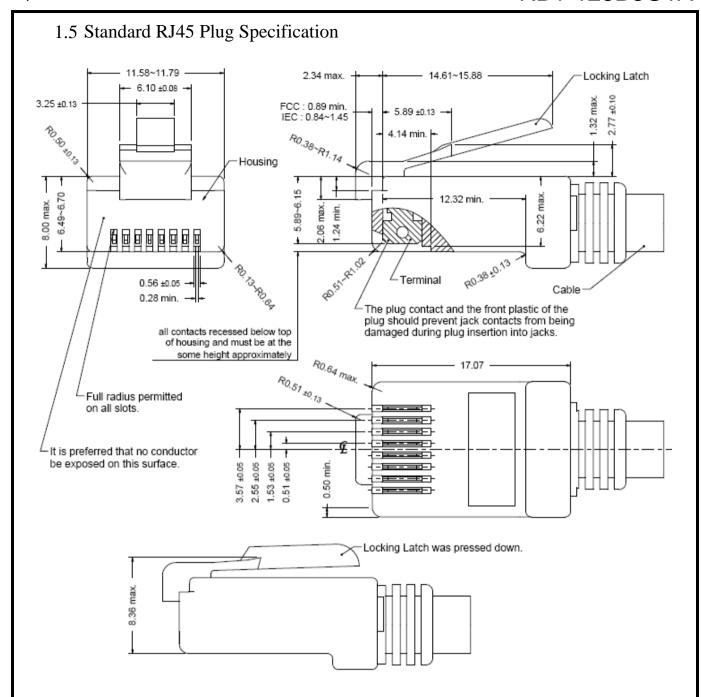


# 1.4 Packing Information

60 pcs finished goods per tray

7 trays(420 pcs finished goods) per inner box

4 Inner boxes(1680 pcs finished goods) per master carton



- All dimensions follow:

FCC subpart F, 68,500, Figure (C)(2)(i) & (C)(2)(ii) & (C)(3)(i) IEC 60603-7

- All plugs must be meeting the requirements of plug Go & No-Go gauge.

  Gauge follow: FCC subpart F, 68,500, Figure (C)(4)(i) & (C)(5)(i)
- There must be no damage to Housing and Locking Latch.
- There must be no nicks and cuts in cable.
- Durability: 750 cycles generally

#### 2. REQUIREMENTS

2.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable.

#### 2.2 Material

2.2.1 Terminal Parts (Underplating : 50µ" min. Nickel overall)

2.2.1.1 RJ Terminal: PH. Bronze, Thickness=0.30mm

Finish: Contact Area: Gold Flash

2.2.1.2 Input Terminal: Brass, Thickness=0.35mm

Finish: 100µ" min. Tin

2.2.1.3 Case Terminal: Brass, Thickness=0.30mm

Finish: 100µ" min. Tin

2.2.2 Plastic Parts <UL94V-0>

2.2.2.1 Housing: PA6T, Black

2.2.2.2 Case : PA6T, Black

2.2.3 Shield Parts: Stainless steel, Thickness=0.20mm, Pre-soldering

#### Spec No.: RB115260-00

#### 2.3 Operating and Storage Temperature

Operating Temperature : 0°C to +70°C

Storage Temperature : -40 °C to +85 °C

#### 2.4 RJ45 specifications

Insulation Resistance :  $500M\Omega$  min.

Insertion force with the latch depressed :22N max

Removal force with the latch depressed :44N max

Locking Force of Plug Latch: 50N min. @ 60+/-5 sec

Durability: 750 cycles

#### 2.5 Performance and Test Description

Product is designed to meet electrical, mechanical and environmental performance requirements specified in below table. All tests are performed at ambient environmental conditions per MIL-STD-1344A and EIA-364 unless otherwise specified.

### 2.6 Packaging and Packing

All parts shall be packaged and packed to protect against physical damage \cdot corrosion and deterioration during shipment and storage.

# 3. ELECTRICAL CHARACTERISTICS 3.1 Schematic **INPUT RJ45** CT R1 o-**OUTPUT** 1:1 TD1+ R2 0-**—** C1 TX1+ **—** C2 TX1-TD1- R3 ○ 1:1 TD2+ R4 0-**—** C3 TX2+ TD2- R5 0-─ C6 TX2-75Ω 1:1 - C4 TX3+ TD3+ R6 ○ TD3- R7 o-1:1 TD4+ R8 0-TD4- R9 0-**─** C8 TX4-2KV 1000pF GND R10 0-Shield **L4** ⊙ **L2** ⊙ Green Yellow L3 ⊙ L1 ⊙—

Emitting Color	λp (nm)	Vf @If=20mA	Ir @Vr=5V
Green	565	1.7 ~2.6 V	10μA max.
Yellow	585	1.7 ~2.6 V	10μA max.

3.2 Transmitter filter & Receiver filter

Type: Balance low pass  $100\Omega$  impedance

Insertion loss: 1~100 MHz -1.0dB max.

Return loss:  $1\sim30 \text{ MHz}$  -18dB min. load  $100\Omega$ 

 $30\sim60\text{MHz}$  -16dB min. load  $100\Omega$ 

 $60\sim80\text{MHz}$  -12dB min. load  $100\Omega$ 

 $80\sim100\text{MHz}$  -10dB min. load  $100\Omega$ 

3.3 Common Mode Rejection

@ 1~100 MHz -30dB min.

3.4 Cross Talk

@ 1~100 MHz -30dB min.

3.5 Inductance @ 100KHz, 0.1V, 8mA DC BIAS

Input (R2-R3), Input (R4-R5), Input (R6-R7), Input (R8-R9): 350 µH min.

3.6 HiPot Test

Input(R2-R3) To Output(C1-C2): 1500Vac 60s or 2250Vdc 60s

Input(R4-R5) To Output(C3-C6): 1500Vac 60s or 2250Vdc 60s

Input(R6-R7) To Output(C4-C5): 1500Vac 60s or 2250Vdc 60s

Input(R8-R9) To Output(C7-C8): 1500Vac 60s or 2250Vdc 60s

# 4. ORDER INFORMATION

# A. LED Code:

L-Green; R-Yellow. < Refer to Schematic of LED>

#### B. Mechanical Code:

UDE Logo, All Spring

## C. Schematics Code:

8G1:8G1 circuit

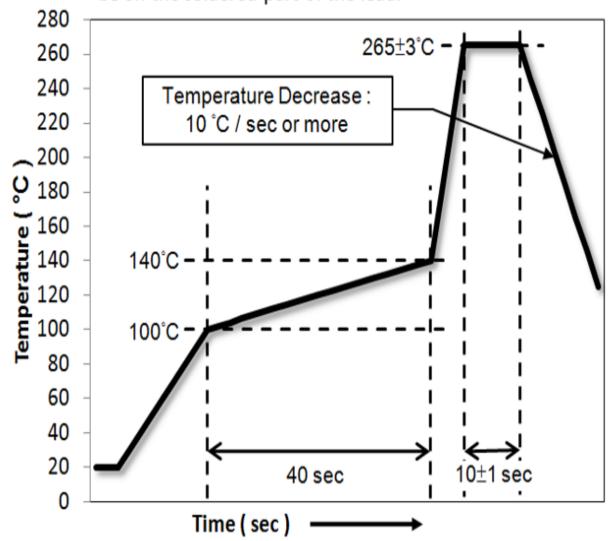
# D. Plating Code:

Underplating	50µ "min. Nickel overall		
Solder Tail	100µ " min. Bright Tin	100µ " min. Matted Tin	
Contact Area	A: Gold Flash	1 : Gold Flash	
	C: 6µ "gold	6 : 6µ " gold	
	B: 10µ " gold		
	D: 15µ " gold	2:15µ "gold	
	F: 30µ " gold	3:30µ "gold	
	G: 50µ " gold	4:50µ "gold	

# 5. DIPPING TEMPERATURE PROFILE

# Note:

The measuring point for the specified temperature shall be on the soldered part of the lead.



6. Revision History				
Issue Date	Revision	Comments	Operator	
2015/11/4	A	Initial Release .	Mark	